MMC mezzanine implemention





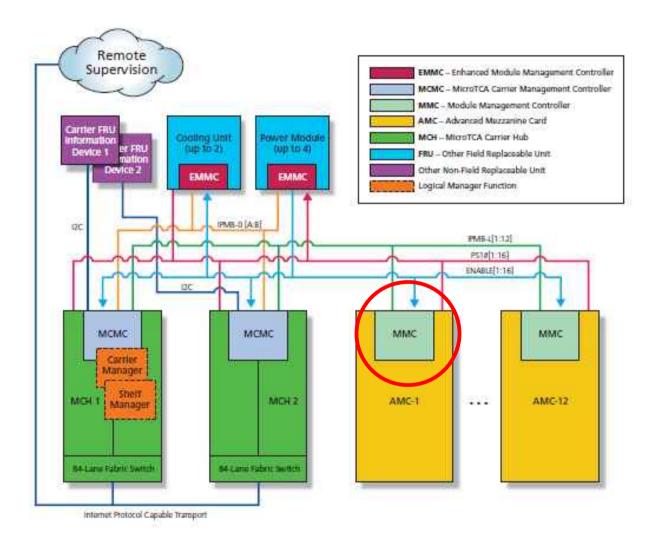
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MMC mezzanine implementation

Outline

- MMC role
- Development motivations
- First implementation
- Final version
- Software

MMC role



- Manage hot swap sequence .
- Board asset information 4
 - Manufacturer,
 - Product name,
 - Model number,
 - Serial number,
 - Geographical information,
 - Version,
 - Features.
 - . . .
- Monitor functions .
 - Board and components temperature,
 - Voltage levels,

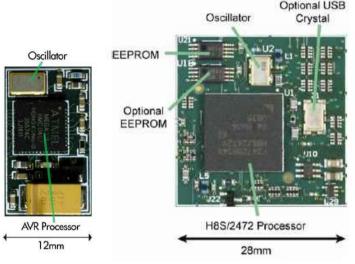
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 Relies on IPMI (Intelligent) Platform Management Interface) communication standard IN2P3/CPPM

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Development motivations

- Developped our own design because
 - Few commercial solutions
 - All proprietary and single source
 - Or expensive IPs
- Use of a mezzanine to:
 - Save room on AMC board
 - Speed-up development
- Received valuable help from Desy who already designed such a functionality (Thanks to Kay Rehlich and Vahan Petrosyan)



Pigeon Point Reference designs (IPs)

First implementation



Final implementation

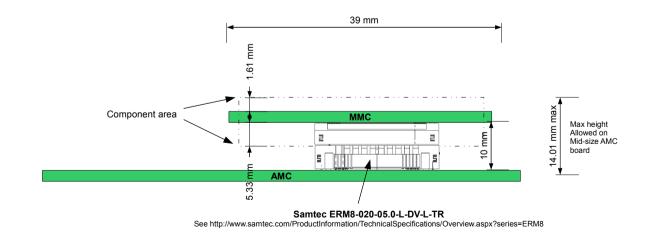
- Improved connector
 - Number of pins grows from 26 to 40
 - JTAG management, User-defined pins
 - Mechanical keying and lock
- Reduced size of mezzanine
- Dimensions compatible with mid-size AMC



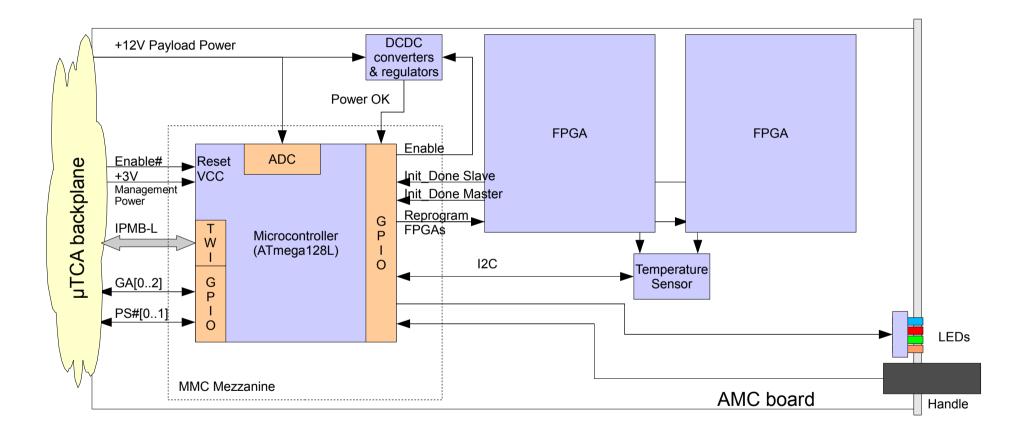
MMC Mezzanine Samtec connector



AMC Samtec connector

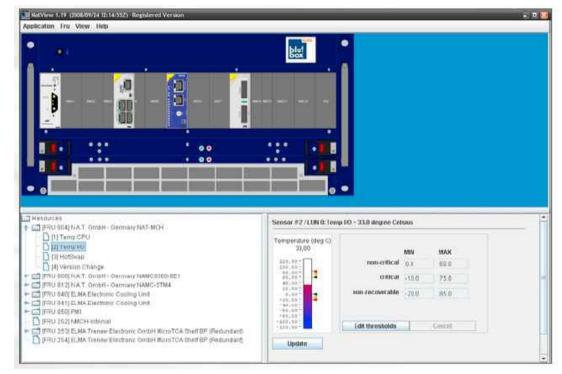


Example of implementation



Software

- Sources courtesy of DESY
- Some improvement and tuning made by CPPM
 - Board insertion state machine
 - Temperature reading
 - Write FRU information in EEPROM
- Tested with MCH commercial board
- Since then, some improvements made by DESY
 - Need to merge modifications



Communication with MMC graphical interface

Conclusion

- Industrial version soon to be released.
- Possibility of shared design/improvements under the agreement from DESY
- CPPM can produce the boards
- User support preferably managed by CERN